



General Description

The MAX97000 audio subsystem combines a mono speaker amplifier with a stereo headphone amplifier and an analog DPST switch. The headphone and speaker amplifiers have independent volume control and on/off control. The four inputs are configurable as two differential inputs or four single-ended inputs.

The entire subsystem is designed for maximum efficiency. The high-efficiency 725mW Class D speaker amplifier operates directly from the battery and consumes no more than 1µA in shutdown mode. The Class H headphone amplifier utilizes a dual-mode charge pump to maximize efficiency while outputting a ground-referenced signal that does not require output coupling capacitors.

The speaker amplifier incorporates a distortion limiter to automatically reduce the volume level when excessive clipping occurs. This allows high gain for low-level signals without compromising the quality of large signals.

All control is performed using the 2-wire, I2C interface. The MAX97000 operates in the extended -40°C to +85°C temperature range, and is available in the 2mm x 2mm, 25-bump WLP package (0.4mm pitch).

Applications

Cell Phones Portable Multimedia Players

Features

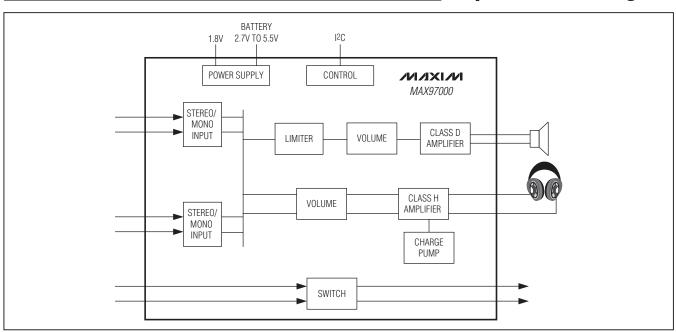
- ♦ 1.6V to 2.0V Headphone Supply Voltage
- ♦ 2.7V to 5.5V Speaker Supply Voltage
- ♦ Internal LDO Allows Single-Supply Operation
- ♦ 725mW Speaker Output (Vpvpp = 3.7V, Zspκ = 8Ω $+68 \mu H)$
- ♦ 40mW/Channel Headphone Output (R_{HP} = 16Ω)
- **♦ Low-Emission Class D Amplifier**
- **♦** Efficient Class H Headphone Amplifier
- **♦** Ground-Referenced Headphone Outputs
- **♦** Two Stereo Single-Ended/Mono Differential Inputs
- ◆ Integrated Distortion Limiter (Speaker Outputs)
- ♦ Integrated DPST Analog Switch
- ♦ No Clicks and Pops
- **♦ TDMA Noise Free**
- ♦ 2mm x 2mm, 25-Bump 0.4mm Pitch WLP Package

Ordering Information

PART	TEMP RANGE	PIN-PACKAGE
MAX97000EWA+	-40°C to +85°C	25 WLP

⁺Denotes a lead(Pb)-free/RoHS-compliant package.

Simplified Block Diagram



MIXIM

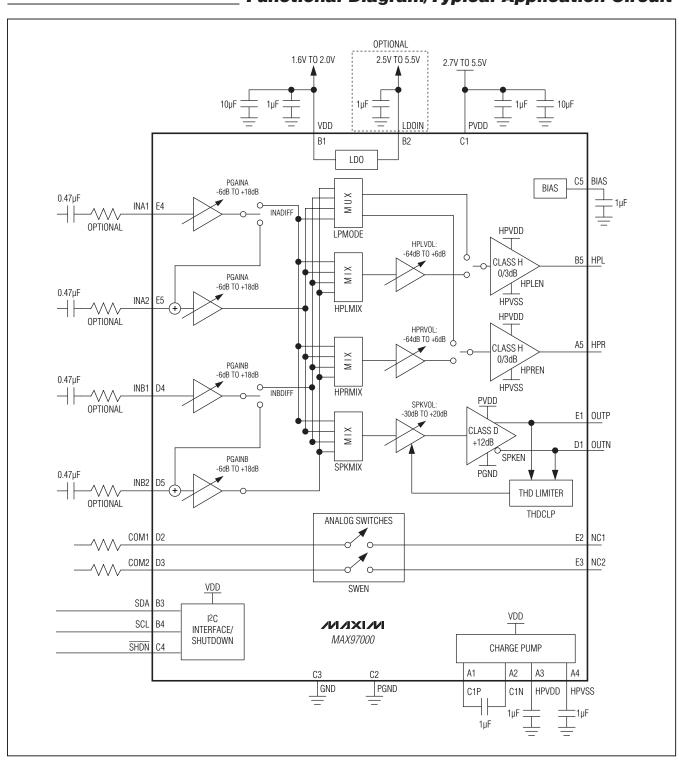
Maxim Integrated Products 1

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Functional Diagram/Typical Application Circuit



ABSOLUTE MAXIMUM RATINGS

(Voltages with respect to GND.)
VDD, HPVDD0.3V to +2.2V
PVDD, LDOIN0.3V to +6.0V
PGND0.1V to +0.1V
HPVSS2.2V to + 0.3V
C1N(HPVSS - 0.3V) to (HPVDD + 0.3V)
C1P 0.3V to (VDD + 0.3V)
HPL, HPR(HPVSS - 0.3V) to (HPVDD +0.3V)
INA1, INA2, INB1, INB2, BIAS0.3V to +6.0V
SDA, SCL, SHDN0.3V to +6.0V
COM1, COM2, NC1, NC2,
OUTP, OUTN0.3V to (PVDD + 0.3V)
Continuous Current In/Out of PVDD, PGND, OUT ±800mA
Continuous Current In/Out of HPR, HPL,
VDD, LDOIN ±140mA

Continuous Current In/Out of COM1,	
COM2, NC1, NC2±150mA	١
Continuous Input Current (all other pins) ±20mA	1
Duration of OUT_ Short Circuit to GND	
or PVDDContinuous	3
Duration of Short Circuit Between OUTP	
and OUTNContinuous	3
Duration of HP_ Short Circuit to GND or VDDContinuous	3
Continuous Power Dissipation (TA = +70°C) Multilayer Board	
25 WLP (derate 19.2mW/°C above +70°C)850mW	/
Junction Temperature+150°C)
Operating Temperature Range40°C to +85°C)
Storage Temperature Range65°C to +150°C	
Soldering Temperature (reflows)+260°C)

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

 $(V_{LDOIN} = V_{PVDD} = V_{\overline{SHDN}} = 3.7V, V_{GND} = V_{PGND} = 0V.$ Input signal applied at INA configured single-ended, preamp gain = 0dB, HPLVOL = HPRVOL = SPKVOL = 0dB, speaker loads (ZSPK) connected between OUTP and OUTN. Headphone loads (RHP) connected from HPL or HPR to GND. SDA and SCL pullup voltage = 1.8V. ZSPK = ∞ , RHP = ∞ . CC1P-C1N = CHPVDD = CHPVSS = CBIAS = 1 μ F. TA = TMIN to TMAX, unless otherwise noted. Typical values are at TA = +25°C.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS		
Speaker Amplifier Supply- Voltage Range	VPVDD	Guaranteed by PSRR test		2.7		5.5	V		
Headphone Amplifier Supply Voltage Range	VDD	Guaranteed by PSRR t	est		1.6		2	V	
LDO Input Supply-Voltage Range	VLDOIN	Guaranteed by PSRR t	est		2.5		5.5	V	
		Low-power mode, TA =	= +25°C,	ILDOIN		1.45	2		
		LPMODE = 0x01		I _{PVDD}		0.4	0.7		
		HP mode, TA = +25°C	, stereo SE	ILDOIN		1.45	2		
Quiescent Supply Current		input on INA, INB disa	bled	IPVDD		0.79	1.2	mA	
Quescent Supply Gurrent		SPK mode, TA = +25°C mono differential input on INB, INA disabled		ILDOIN		0.42	0.75	-	
				IPVDD		1.38	2.2		
		SPK + HP mode, TA = +25°C stereo		ILDOIN		1.45	2		
		SE input on INA, INB di	sabled	IPVDD		1.8	2.7		
		$T_A = +25$ °C, internal gain, software $\frac{ PVDD }{ LDOIN }$ $T_A = +25$ °C, internal gain, $ PVDD + LDOIN $, hardware		IPVDD		90	175		
Shutdown Current	ISHDN			ILDOIN		60	110		
Shutdown Current	ISHDIN			LDOIN,			1	HΑ	
Turn-On Time	ton	Time from power-on to including soft-start	Time from power-on to full operation including soft-start			8		ms	
		T 0500	Gain = -6dB	, -3dB		41.2			
Input Resistance	RIN	$T_A = +25$ °C, internal gain $Gain = 0dB$ $Gain = +180$	Gain = 0dB	to +9dB	16	20.6	27	kΩ	
			lB	5.5	7.2	9.5			
Feedback Resistance	RF	T _A = +25°C, external g	gain		19	20	21	kΩ	

ELECTRICAL CHARACTERISTICS (continued)

 $(VLDOIN = VPVDD = V\overline{SHDN} = 3.7V, VGND = VPGND = 0V.$ Input signal applied at INA configured single-ended, preamp gain = 0dB, HPLVOL = HPRVOL= SPKVOL = 0dB, speaker loads (ZSPK) connected between OUTP and OUTN. Headphone loads (RHP) connected from HPL or HPR to GND. SDA and SCL pullup voltage = 1.8V. ZSPK = ∞ , RHP = ∞ . CC1P-C1N = CHPVDD = CHPVSS = CBIAS = 1 μ F. TA = TMIN to TMAX, unless otherwise noted. Typical values are at TA = +25°C.) (Note 1)

PARAMETER	SYMBOL	COND	ITIONS	MIN	TYP	MAX	UNITS
		Preamp = 0dB			2.3		
Maximum Input Signal Swing		Preamp = +18dB		0.29			V _{P-P}
		Preamp = external gai	n	2.3	3 x RIN,EX/	RF	
Common Mada Daigatian Datia	CMDD	f = 1kHz (differential	Gain = 0dB		55		٩D
Common-Mode Rejection Ratio	CMRR	input mode)	Gain = +18dB		32		dB
Input DC Voltage		IN inputs		1.125	1.2	1.275	V
Bias Voltage	VBIAS			1.13	1.2	1.27	V
SPEAKER AMPLIFIER							
		T _A = +25°C, SPKM =	1		±0.5	±4	
Output Offset Voltage	Vos	T _A = +25°C, SPKVOL IN_DIFF = 0V	= 0dB, SPKMIX = 0x01,		±1.5		mV
Click-and-Pop Level	Кср	Peak voltage, T _A = +25°C, A-weighted, 32 samples per	Into shutdown		-70		dBV
	1.01	a a a a a a d a v a luma a a t	Out of shutdown		-70		
	PSRR	T _A = +25°C (Note 2)	$V_{PVDD} = 2.7V \text{ to } 5.5V$	50	75		dB
			f = 217Hz, VRIPPLR = 200mVP-P		65		
Power-Supply Rejection Ratio			f = 1kHz, VRIPPLR = 200mVP-P		65		
			f = 20kHz, VRIPPLR = 200mVp-p		59		
		THD+N ≤ 1%,	VPVDD = 4.2V		930		
Output Power		f = 1kHz,	V _{PVDD} = 3.7V		725		mW
		$Z_{SPK} = 8\Omega + 68\mu H$ (Note 3)	VPVDD = 3.3V		562		
Total Harmonic Distortion + Noise	THD+N	f = 1kHz, POUT = 360r Z _{SPK} = 8 Ω + 68 μ H	mW, T _A = +25°C,		0.05	0.6	%
Signal-to-Noise Ratio	SNR	A-weighted, SPKMIX = 0x03, referenced to	IN_DIFF = 0 (single-ended)		93		dB
		725mW	IN_DIFF = 1 (differential)		93		
Oscillator Frequency	fosc				250		kHz
Spread-Spectrum Bandwidth					±20		kHz
Gain				11.5	12	12.5	dB
Current Limit					1.5		А
Efficiency	η	Pout = 725mW, f = 1kl	Hz, Zspk = 8Ω + 68μ H		87		%
Output Noise		A-weighted, (SPKMIX SPKVOL = 0dB		50		μVRMS	

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ELECTRICAL CHARACTERISTICS (continued)

 $(VLDOIN = VPVDD = V\overline{SHDN} = 3.7V, VGND = VPGND = 0V. Input signal applied at INA configured single-ended, preamp gain = 0dB, HPLVOL = HPRVOL = SPKVOL = 0dB, speaker loads (ZSPK) connected between OUTP and OUTN. Headphone loads (RHP) connected from HPL or HPR to GND. SDA and SCL pullup voltage = 1.8V. ZSPK = <math>\infty$, RHP = ∞ . CC1P-C1N = CHPVDD = CHPVSS = CBIAS = 1 μ F. TA = TMIN to TMAX, unless otherwise noted. Typical values are at TA = +25°C.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
CHARGE PUMP							
		VHPL = VHPR = 0V		80	83	85	
Charge-Pump Frequency		VHPL = VHPR = 0.2V			665		kHz
		VHPL = VHPR = 0.5V			500		
Positivo Output Voltago	V/	VHPL, VHPR > VTH			1.8		V
Positive Output Voltage	VHPVDD	VHPL, VHPR < VTH			0.9		7 v
Negative Output Voltage	\/p\co	VHPL, VHPR > VTH			-1.8		V
Thegative Output voltage	VHPVSS	VHPL, VHPR < VTH			-0.9		V
Headphone Output Voltage	V _{TH1}	Output voltage at which switches between fast	• , ,	0.1	0.16	0.21	V
Threshold	V _{TH2}	Output voltage at which switches modes, Vou		0.40	0.46	0.52	V
Mode Transition Timeouts		Time it takes for the cl transition from invert to			32		ms
Mode Hansillon Hilleouts		Time it takes for the cl transition from split to			20		μs
HEADPHONE AMPLIFIERS							
		TA = +25°C volume at mute			±0.15	±0.6	
Output Offset Voltage	Vos	T _A = +25°C, HP_VOL IN_DIFF = 0	$= 0dB, HP_MIX = 0x1,$		±0.5		mV
Click-and-Pop Level	КСР	Peak voltage, T _A = +25°C, A-weighted, 32 samples per second,	Into shutdown		-74		- dBV
	NCP	volume at mute (Note 2)	Out of shutdown		-74		UDV
			$V_{LDOIN} = 2.5V \text{ to } 5.5V$	70	85		
			f = 217Hz, VRIPPLE = 200mVp-p		84		
Power-Supply Rejection Ratio	PSRR	$T_A = +25^{\circ}C \text{ (Note 2)}$	f = 1kHz, VRIPPLE = 200mVp-p		80		dB
			f = 20kHz, VRIPPLE = 200mVp-p		62		
			$R_{HP} = 16\Omega$		40		
Output Power		 THD N = 19/	RHP = 32Ω		23		
	Pout	POUT $f = 1 \text{kHz}$	$RHP = 32\Omega,$ LPMODE = 1, LP gain = 3dB		34		mW
Channel-to-Channel Gain Tracking		TA = +25°C, HPL to H maximum, HPLMIX = IN_DIFF = 0	IPR, volume at 0x01, HPRMIX = 0x02,		±0.3	±2.5	%

ELECTRICAL CHARACTERISTICS (continued)

 $(VLDOIN = VPVDD = V\overline{SHDN} = 3.7V, VGND = VPGND = 0V.$ Input signal applied at INA configured single-ended, preamp gain = 0dB, HPLVOL = HPRVOL= SPKVOL = 0dB, speaker loads (ZSPK) connected between OUTP and OUTN. Headphone loads (RHP) connected from HPL or HPR to GND. SDA and SCL pullup voltage = 1.8V. ZSPK = ∞ , RHP = ∞ . CC1P-C1N = CHPVDD = CHPVSS = CBIAS = 1 μ F. TA = TMIN to TMAX, unless otherwise noted. Typical values are at TA = +25°C.) (Note 1)

Noise Signal-to-Noise Ratio Signal-to-Noise S	PARAMETER	SYMBOL	COND	ITIONS	MIN	TYP	MAX	UNITS	
Noise FILI-HN f = 1 kHz RHP = 18Ω 0.03 0.1 %	Total Harmonic Distortion +	TLID . NI	Pout = 10mW,	$RHP = 32\Omega$		0.02		0/	
Signal Analo	Noise	IHD+N	l .	$RHP = 16\Omega$		0.03	0.1	7 %	
Capacitive Drive CL 200 pF Crosstalk HPL to HPR, HPR to HPL, f = 20Hz to 20kHz 65 dB ANALOG SWITCH Total Marketing and the properties of the prop	Signal-to-Noise Ratio	SNR				100		dB	
Crosstalk	Slew Rate	SR				0.35		V/µs	
No.	Capacitive Drive	CL				200		pF	
No. = 20mA, VCOM_ = 0V and PVDD, SWEN = 1 TA = +25°C 1.6 4 2.0 2.	Crosstalk		HPL to HPR, HPR to H	PL, f = 20Hz to 20kHz		65		dB	
On-Resistance RON SWEN = 1	ANALOG SWITCH								
SWEN = 1	On Posistance	BON		T _A = +25°C		1.6	4	- 0	
Total Harmonic Distortion + VCMCOM_= PVDO/2, f = 1kHz, SWEN = 1, ZSPK = 8Ω + 68µH No series resistors No series resisto	On-nesistance	TION		TA = TMIN to TMAX			5.2	32	
F = 1kHz, SWEN = 1, ZSPK = 8Ω + 68μH No series resistors 0.3 No series resistors 0.3	Total Harmonic Distortion +					0.05		0/	
Off-Isolation f = 10kHz, referred to signal applied to NC1 and NC2 105 dB PREAMPLIFIER PGAIN_ = 000 -6.5 -6 -5.5 PGAIN_ = 001 -3.5 -3 -2.5 PGAIN_ = 010 -0.5 0 0.5 PGAIN_ = 011 2.5 3 3.5 dB PGAIN_ = 100 5.5 6 6.5 PGAIN_ = 101 8.5 9 9.5 PGAIN_ = 101 8.5 9 9.5 PGAIN_ = 110 17.5 18 18.5 VOLUME CONTROL HP_VOL = 0x1F 5.5 6 6.5 HP_VOL = 0x00 -68 -64 -60 GB SPKVOL = 0x3F 19 20 21 21 SPKVOL = 0x00 -31 -30 -29 Mute Attenuation f = 1kHz Speaker 109 dB LIMITER Attack Time 1 ms THDT1 = 0 1.4 s	Noise		f = 1kHz, $SWEN = 1$,	No series resistors		0.3		7 %	
PGAIN_ = 000	Off-Isolation		f = 10kHz, referred to	f = 10kHz, referred to signal applied to NC1		105		dB	
PGAIN_ = 001	PREAMPLIFIER								
PGAIN_ = 010			PGAIN_ = 000		-6.5	-6	-5.5		
PGAIN_ = 011			PGAIN_ = 001		-3.5	-3	-2.5	dB	
PGAIN_ = 100			PGAIN_ = 010	-0.5	0	0.5			
PGAIN_ = 101	Gain		PGAIN_ = 011	2.5	3	3.5			
PGAIN_ = 110			PGAIN_ = 100		5.5	6	6.5		
VOLUME CONTROL HP_VOL = 0x1F 5.5 6 6.5 HP_VOL = 0x00 -68 -64 -60 SPKVOL = 0x3F 19 20 21 SPKVOL = 0x00 -31 -30 -29 Mute Attenuation f = 1kHz Speaker 109 dB Zero-Crossing Detection Timeout 101 ms LIMITER Attack Time 1 ms Release Time Constant THDT1 = 0 1.4 s			PGAIN_ = 101		8.5	9	9.5		
Volume Level HP_VOL = 0x1F 5.5 6 6.5 HP_VOL = 0x00 -68 -64 -60 SPKVOL = 0x3F 19 20 21 SPKVOL = 0x00 -31 -30 -29 Mute Attenuation F = 1kHz Speaker Headphone 109 Headphone Jump Text Index			PGAIN_ = 110	17.5	18	18.5			
Volume Level HP_VOL = 0x00 SPKVOL = 0x3F -68 -64 -60 SPKVOL = 0x00 dB Mute Attenuation f = 1kHz Speaker Headphone 109 Headphone dB Zero-Crossing Detection Timeout 100 ms LIMITER Attack Time 1 ms THDT1 = 0 1.4 s	VOLUME CONTROL								
SPKVOL = 0x3F 19 20 21 SPKVOL = 0x00 -31 -30 -29 Mute Attenuation f = 1kHz Speaker 109 Headphone 101 Zero-Crossing Detection Timeout 100 ms LIMITER Attack Time 1 ms Release Time Constant 1.4 S			HP_VOL = 0x1F		5.5	6	6.5		
SPKVOL = 0x3F 19 20 21	Volumo Lovol		HP_VOL = 0x00		-68	-64	-60	4D	
Mute Attenuation f = 1kHz Speaker 109 Headphone 101 Meadphone dB Zero-Crossing Detection Timeout 100 ms ms LIMITER 1 ms ms Attack Time 1 ms ms THDT1 = 0 1.4 s	volume Level		SPKVOL = 0x3F		19	20	21	ab ab	
Mute Attenuation f = 1kHz Headphone 101 dB Zero-Crossing Detection Timeout 100 ms LIMITER 1 ms Attack Time 1 ms Release Time Constant 1.4 s			SPKVOL = 0x00		-31	-30	-29]	
Headphone	Muta Attanuation		f 41/11-	Speaker		109		4D	
Timeout 100 ms LIMITER 1 ms Attack Time 1 ms Release Time Constant 1.4 s	iviute Attenuation		T = 1KHZ	Headphone		101		d aR	
Attack Time 1 ms Release Time Constant THDT1 = 0 1.4	Zero-Crossing Detection Timeout					100		ms	
Release Time Constant THDT1 = 0 1.4	LIMITER								
Release Time Constant	Attack Time					1		ms	
Release Time Constant	D.L. T. C		THDT1 = 0			1.4			
	Release Time Constant		THDT1 = 1			2.8		s	

DIGITAL I/O CHARACTERISTICS

 $(VLDOIN = VPVDD = V\overline{SHDN} = 3.7V, VGND = VPGND = 0V. TA = TMIN to TMAX, unless otherwise noted. Typical values are at TA = +25°C.) (Note 1)$

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
DIGITAL INPUTS (SDA, SCL, SH	IDN)					
Input Voltage High	VIH		1.3			V
Input Voltage Low	VIL				0.5	V
Input Hysteresis	VHYS			200		mV
Input Capacitance	CIN			10		pF
lanut Lankaga Current	Luci	T _A = +25°C			±1.0	
Input Leakage Current	IIN	V _{LDOIN} = 0, T _A = +25°C			±1.0	μΑ
DIGITAL OUTPUTS (SDA Open Drain)						
Output Low Voltage	VoL	ISINK = 3mA			0.4	V

I²C TIMING CHARACTERISTICS

 $(VLDOIN = VPVDD = V\overline{SHDN} = 3.7V, VGND = VPGND = 0V. TA = TMIN to TMAX, unless otherwise noted. Typical values are at TA = +25°C.) (Note 1)$

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Serial-Clock Frequency	fscl		0		400	kHz
Bus Free Time Between STOP and START Conditions	tBUF		1.3			μs
Hold Time (Repeated) START Condition	tHD,STA		0.6			μs
SCL Pulse-Width Low	tLOW		1.3			μs
SCL Pulse-Width High	tHIGH		0.6			μs
Setup Time for a Repeated START Condition	tsu,sta		0.6			μs
Data Hold Time	thd,dat		0		900	ns
Data Setup Time	tsu,dat		100			ns
SDA and SCL Receiving Rise Time	tR	(Note 4)	20 + 0.1C _B		300	ns
SDA and SCL Receiving Fall Time	tF	(Note 4)	20 + 0.1C _B		300	ns
SDA Transmitting Fall Time	tF	(Note 4)	20 + 0.1CB		300	ns
Setup Time for STOP Condition	tsu,sto		0.6			μs
Bus Capacitance	Св				400	рF
Pulse Width of Suppressed Spike	tsp		0		50	ns

Note 1: 100% production tested at TA = +25°C. Specifications overtemperature limits are guaranteed by design.

Note 2: Amplifier inputs are AC-coupled to GND.

Note 3: Class D amplifier testing performed with a resistive load in series with an inductor to simulate an actual speaker load.

Note 4: CB is in pF.

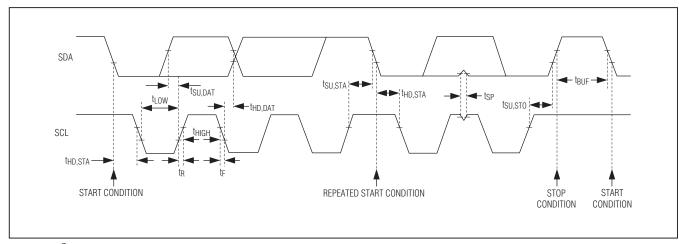
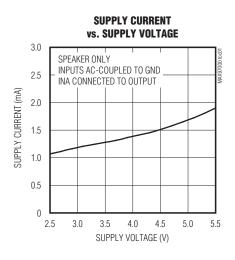


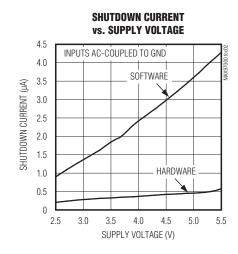
Figure 1. I²C Interface Timing Diagram

Typical Operating Characteristics

 $(V_{LDOIN} = V_{PVDD} = 3.7V, V_{GND} = V_{PGND} = 0V. \ Single-ended inputs, preamp gain = 0dB, HPLVOL = HPRVOL = SPKVOL = 0dB. \ Speaker loads (ZSPK) connected between OUTP and OUTN. Headphone loads (RHP) connected from HPL or HPR to GND. ZSPK = <math>\infty$, RHP = ∞ . CC1P-C1N = CHPVDD = CHPVSS = CBIAS = 1 μ F. TA = +25°C, unless otherwise noted.)

GENERAL

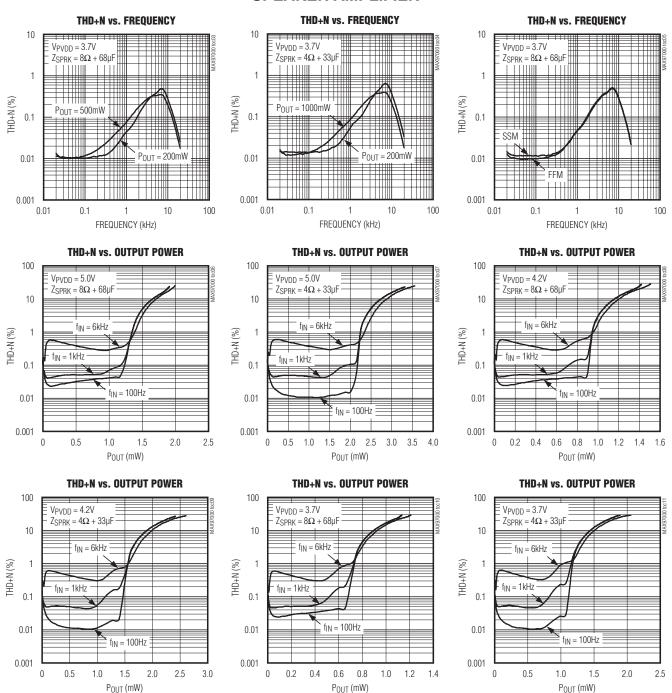




Typical Operating Characteristics (continued)

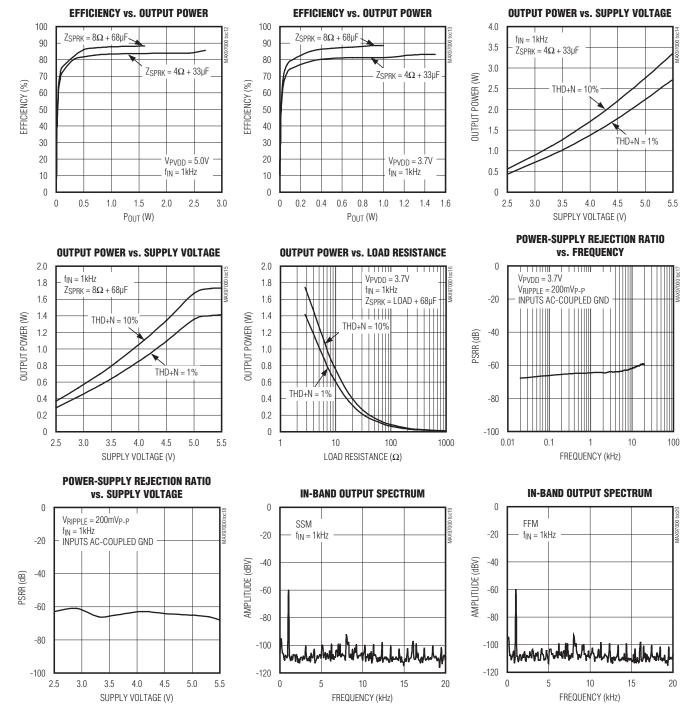
 $(V_{LDOIN} = V_{PVDD} = 3.7V, V_{GND} = V_{PGND} = 0V. \ Single-ended \ inputs, preamp \ gain = 0dB, HPLVOL = HPRVOL = SPKVOL = 0dB. \ Speaker \ loads (ZSPK) \ connected \ between OUTP \ and OUTN. \ Headphone \ loads (R_{HP}) \ connected \ from \ HPL \ or \ HPR \ to \ GND. \ ZSPK = <math>\infty$, $R_{HP} = \infty$. $C_{C1P-C1N} = C_{HPVDD} = C_{HPVSS} = C_{BIAS} = 1\mu F. \ T_A = +25^{\circ}C, \ unless \ otherwise \ noted.)$

SPEAKER AMPLIFIER



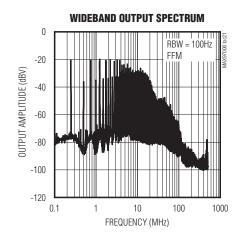
Typical Operating Characteristics (continued)

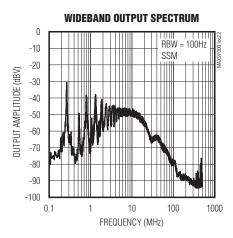
 $(VLDOIN = VPVDD = 3.7V, VGND = VPGND = 0V. Single-ended inputs, preamp gain = 0dB, HPLVOL = HPRVOL = SPKVOL = 0dB. Speaker loads (ZSPK) connected between OUTP and OUTN. Headphone loads (RHP) connected from HPL or HPR to GND. <math>ZSPK = \infty$, $RHP = \infty$. $CC1P-C1N = CHPVDD = CHPVSS = CBIAS = 1\mu F. TA = +25°C, unless otherwise noted.)$

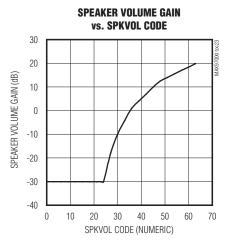


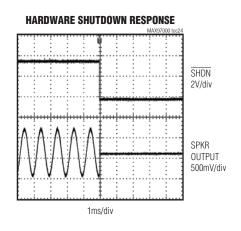
Typical Operating Characteristics (continued)

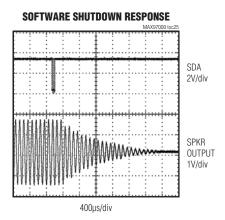
 $(V_{LDOIN} = V_{PVDD} = 3.7V, V_{GND} = V_{PGND} = 0V. \ Single-ended inputs, preamp gain = 0dB, HPLVOL = HPRVOL = SPKVOL = 0dB. \ Speaker loads (ZSPK) connected between OUTP and OUTN. Headphone loads (RHP) connected from HPL or HPR to GND. ZSPK = <math>\infty$, RHP = ∞ . CC1P-C1N = CHPVDD = CHPVSS = CBIAS = 1 μ F. TA = +25°C, unless otherwise noted.)

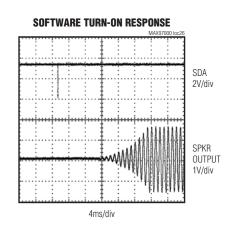






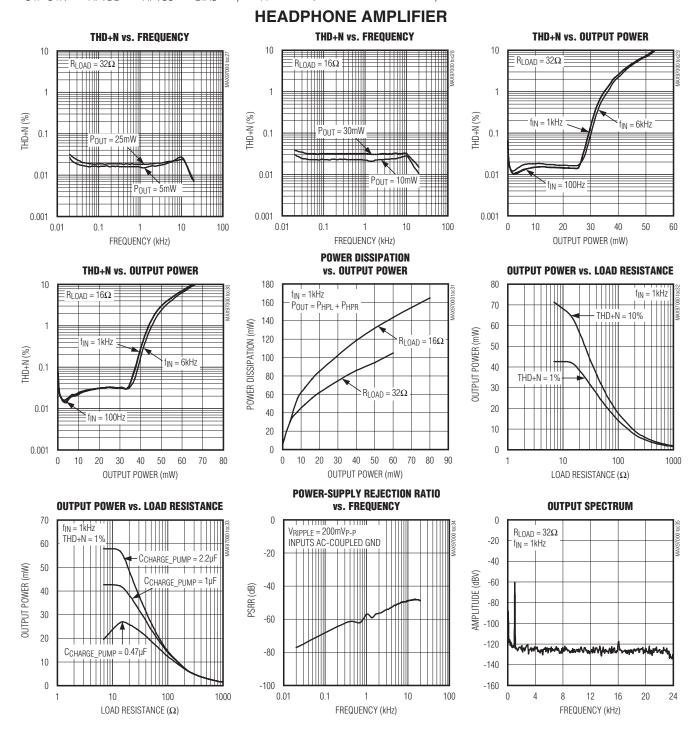






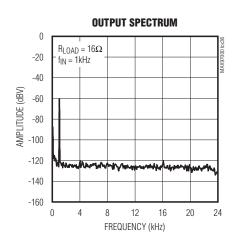
Typical Operating Characteristics (continued)

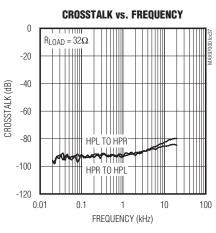
 $(V_{LDOIN} = V_{PVDD} = 3.7V, V_{GND} = V_{PGND} = 0V. Single-ended inputs, preamp gain = 0dB, HPLVOL = HPRVOL = SPKVOL = 0dB. Speaker loads (ZSPK) connected between OUTP and OUTN. Headphone loads (RHP) connected from HPL or HPR to GND. <math>Z_{SPK} = \infty$, $R_{HP} = \infty$. $C_{C1P-C1N} = C_{HPVDD} = C_{HPVSS} = C_{BIAS} = 1\mu F. T_A = +25^{\circ}C$, unless otherwise noted.)

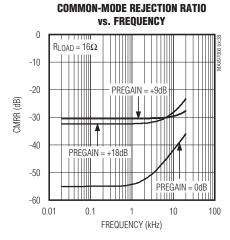


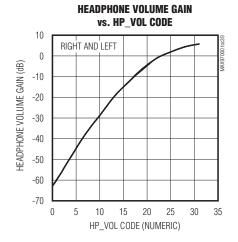
Typical Operating Characteristics (continued)

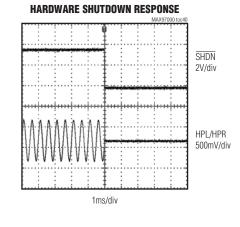
 $(V_{LDOIN} = V_{PVDD} = 3.7V, V_{GND} = V_{PGND} = 0V. \ Single-ended \ inputs, preamp \ gain = 0dB, HPLVOL = HPRVOL = SPKVOL = 0dB. \ Speaker \ loads (ZSPK) \ connected \ between OUTP \ and OUTN. \ Headphone \ loads (R_{HP}) \ connected \ from \ HPL \ or \ HPR \ to \ GND. \ ZSPK = <math>\infty$, $R_{HP} = \infty$. $C_{C1P-C1N} = C_{HPVDD} = C_{HPVSS} = C_{BIAS} = 1\mu F. \ T_A = +25^{\circ}C, \ unless \ otherwise \ noted.)$

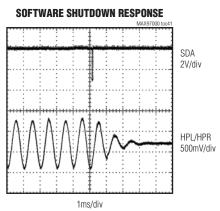


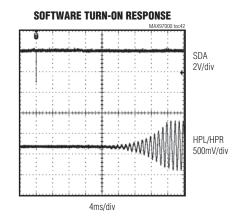








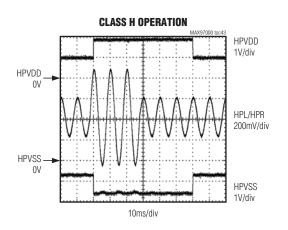


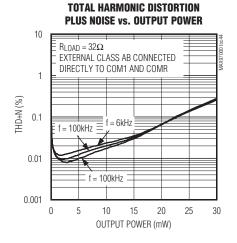


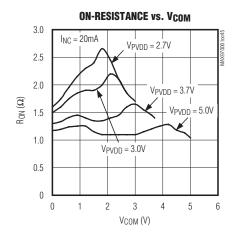
Typical Operating Characteristics (continued

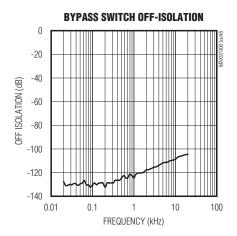
 $(V_{LDOIN} = V_{PVDD} = 3.7V, V_{GND} = V_{PGND} = 0V. \ Single-ended \ inputs, \ preamp \ gain = 0dB, \ HPLVOL = HPRVOL = SPKVOL = 0dB. \ Speaker \ loads (ZSPK) \ connected \ between OUTP \ and OUTN. \ Headphone \ loads (RHP) \ connected \ from \ HPL \ or \ HPR \ to \ GND. \ ZSPK = <math>\infty$, \ RHP = ∞ . \ CC1P-C1N = CHPVDD = CHPVSS = CBIAS = 1 μ F. \ TA = +25°C, \ unless \ otherwise \ noted.)

ANALOG SWITCH

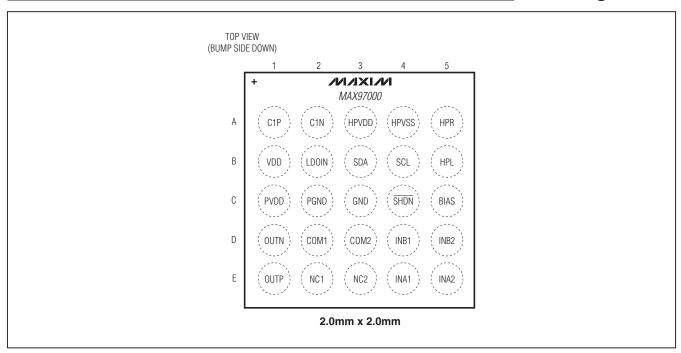








Pin Configuration



Pin Description

BUMP	NAME	FUNCTION
A1	C1P	Charge-Pump Flying Capacitor Positive Terminal. Connect a 1µF capacitor between C1P and C1N.
A2	C1N	Charge-Pump Flying Capacitor Negative Terminal. Connect a 1µF capacitor between C1P and C1N.
A3	HPVDD	Headphone Amplifier Positive Power Supply. Bypass with a 1µF capacitor to PGND.
A4	HPVSS	Headphone Amplifier Negative Power Supply. Bypass with a 1µF capacitor to PGND.
A5	HPR	Headphone Amplifier Right Output
B1	VDD	LDO Output and Headphone Amplifier Supply. Bypass with a 1µF and a 10µF capacitor to GND. Power VDD or LDOIN. When powering VDD, leave LDOIN unconnected.
B2	LDOIN	LDO Input. Generates VDD if no 1.8V power supply is available. Leave unconnected to disable. Do not power VDD when powering LDOIN.
В3	SDA	Serial Data Input/Output. Connect a pullup resistor from SDA to the I ² C bus supply.
B4	SCL	Serial-Clock Input. Connect a pullup resistor from SCL to the I ² C bus supply.
B5	HPL	Headphone Amplifier Left Output
C1	PVDD	Class D Power Supply. Bypass with a 1µF and a 10µF capacitor to PGND.
C2	PGND	Class D Power Ground and Charge Pump Ground
C3	GND	Analog Ground.
C4	SHDN	Active-Low Shutdown
C5	BIAS	Common-Mode Bias. Bypass to GND with a 1µF capacitor.

Pin Description (continued)

BUMP	NAME	FUNCTION
D1	OUTN	Negative Speaker Output
D2	COM1	Analog Switch 1 Input
D3	COM2	Analog Switch 2 Input
D4	INB1	Input B1. Left or negative input.
D5	INB2	Input B2. Right or positive input.
E1	OUTP	Positive Speaker Output
E2	NC1	Analog Switch 1 Output
E3	NC2	Analog Switch 2 Output
E4	INA1	Input A1. Left or negative input.
E5	INA2	Input A2. Right or positive input.

Detailed Description

The MAX97000 audio subsystem combines a mono speaker amplifier with a stereo headphone amplifier and an analog DPST switch. The high-efficiency 725mW Class D speaker amplifier operates directly from the battery and consumes no more than 1µA when in shutdown mode. The headphone amplifier utilizes a dual-mode charge pump and a Class H output stage to maximize efficiency while outputting a ground-referenced signal that does not require output coupling capacitors. The headphone and speaker amplifiers have independent volume control and on/off control. The four inputs are configurable as two differential inputs or four single-ended inputs. All control is performed using the 2-wire, I2C interface.

The speaker amplifier incorporates a distortion limiter to automatically reduce the volume level when excessive clipping occurs. This allows high gain for low-level signals without compromising the quality of large signals.

Internal Linear Regulator

The MAX97000 includes an internal regulator (LDOIN) to generate VDD in cases where no 1.8V supply is available. Using the regulator allows single-supply operation directly from a Li+ battery. To enable the internal regulator apply a power supply to LDOIN and do not connect power to VDD. When not using the internal regulator, leave LDOIN unconnected and power VDD from a 1.8V supply.

Signal Path

The MAX97000 signal path consists of flexible inputs, signal mixing, volume control, and output amplifiers (Figure 2). The inputs can be configured for single-ended or differential signals (Figure 3). The internal preamplifiers feature programmable gain settings using internal resistors and an external gain setting using a trimmed internal feedback resistor. The external option allows any desired gain to be selected. Following preamplification, the input signals are mixed, volume adjusted, and routed to the headphone and speaker amplifiers based on the desired configuration.

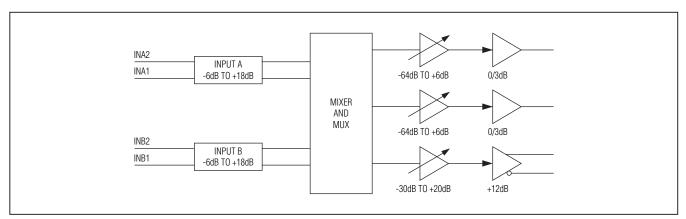


Figure 2. Signal Path

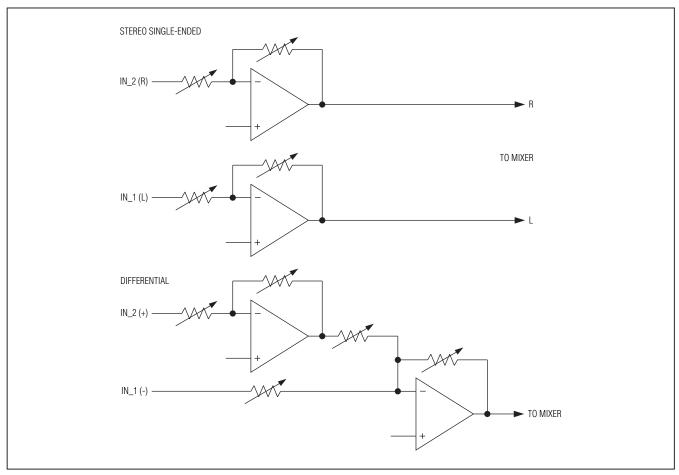


Figure 3. Differential and Stereo Single-Ended Input Configurations

Mixers

The MAX97000 features independent mixers for the left headphone, right headphone, and speaker paths. Each output can select any combination of any inputs. This allows for mixing two audio signals together and routing independent signals to the headphone and speaker amplifiers. If one of the inputs is not selected by either mixer, it is automatically powered down to save power.

Class D Speaker Amplifier

The MAX97000 Class D speaker amplifier utilizes active emissions limiting and spread-spectrum modulation to minimize the EMI radiated by the amplifier.

Ultra-Low EMI Filterless Output Stage

Traditional Class D amplifiers require the use of external LC filters or shielding to meet EN55022B electromagnetic-interference (EMI) regulation standards. Maxim's active emissions limiting edge-rate control circuitry and spread-spectrum modulation reduces EMI emissions, while maintaining up to 87% efficiency. Maxim's spread-spectrum modulation mode flattens wideband spectral

components, while proprietary techniques ensure that the cycle-to-cycle variation of the switching period does not degrade audio reproduction or efficiency. The MAX97000's spread-spectrum modulator randomly varies the switching frequency by ±20kHz around the center frequency (250kHz). Above 10MHz, the wideband spectrum looks like noise for EMI purposes (see Figure 4).

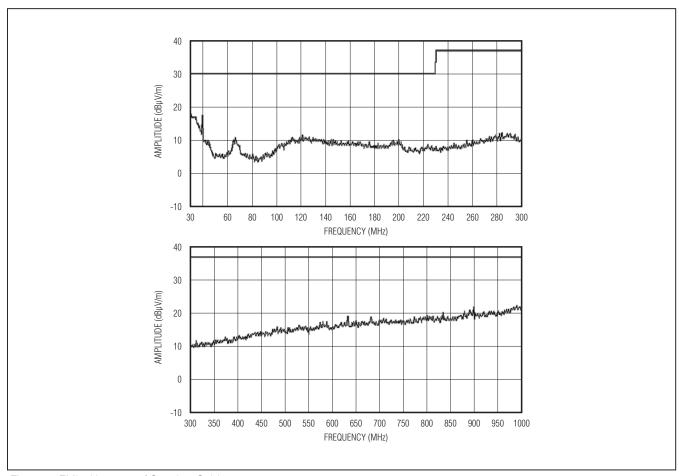


Figure 4. EMI with 15cm of Speaker Cable

Distortion Limiter

The MAX97000 speaker amplifiers integrate a limiter to provide speaker protection and audio compression. When enabled, the limiter monitors the audio signal at the output of the Class D speaker amplifier and decreases the gain if the distortion exceeds the predefined threshold. The limiter automatically tracks the battery voltage to reduce the gain as the battery voltage drops.

Figure 5 shows the typical output vs. input curves with and without the distortion limiter. The dotted line shows the maximum gain for a given distortion limit without the distortion limiter. The solid line shows how, with the distortion limiter enabled, the gain can be increased without exceeding the set distortion limit. When the limiter is enabled, selecting a high gain level results in peak signals being attenuated while low signals are left unchanged. This increases the perceived loudness without the harshness of a clipped waveform.

Analog Switch

The MAX97000 integrates a DPST analog audio switch. This switch can be used to disconnect an independent audio signal, or drive the 8Ω speaker by connecting NC1 and NC2 to OUTN and OUTP, respectively. Unlike discrete solutions, the switch design reduces coupling of Class D switching noise to the COM_ inputs. This eliminates the need for a costly T-switch. Drive COM1 and COM2 with a low-impedance source to minimize noise on the pins. In applications that do not require the analog switch, leave COM1, COM2, NC1, and NC2 unconnected.

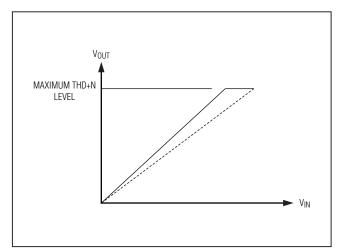


Figure 5. Limiter Gain Curve

Headphone Amplifier DirectDrive

Traditional single-supply headphone amplifiers have outputs biased at a nominal DC voltage (typically half the supply). Large coupling capacitors are needed to block this DC bias from the headphone. Without these capacitors, a significant amount of DC current flows to the headphone, resulting in unnecessary power dissipation and possible damage to both headphone and headphone amplifier.

Maxim's DirectDrive® architecture uses a charge pump to create an internal negative supply voltage. This allows the headphone outputs of the MAX97000 to be biased at GND while operating from a single supply (Figure 6). Without a DC component, there is no need for the large DC-blocking capacitors. Instead of two large (220µF, typ) capacitors, the MAX97000 charge pump requires three small ceramic capacitors,

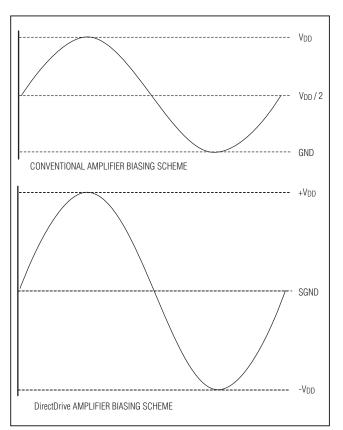


Figure 6. Traditional Amplifier Output vs. MAX97000 DirectDrive Output

DirectDrive is a registered trademark of Maxim Integrated Products, Inc.

conserving board space, reducing cost, and improving the frequency response of the headphone amplifier. See the Output Power vs. Load Resistance graph in the *Typical Operating Characteristics* for details of the possible capacitor sizes. There is a low DC voltage on the amplifier outputs due to amplifier offset. However, the offset of the MAX97000 is typically $\pm 0.15 \text{mV}$, which, when combined with a 32Ω load, results in less than $5\mu\text{A}$ of DC current flow to the headphones.

In addition to the cost and size disadvantages of the DC-blocking capacitors required by conventional headphone amplifiers, these capacitors limit the amplifier's low-frequency response and can distort the audio signal. Previous attempts at eliminating the output-coupling capacitors involved biasing the headphone return (sleeve) to the DC bias voltage of the headphone amplifiers. This method raises some issues:

- The sleeve is typically grounded to the chassis.
 Using the midrail biasing approach, the sleeve must be isolated from system ground, complicating product design.
- During an ESD strike, the amplifier's ESD structures are the only path to system ground. Thus, the amplifier must be able to withstand the full energy from an ESD strike.
- When using the headphone jack as a line out to other equipment, the bias voltage on the sleeve may conflict with the ground potential from other equipment, resulting in possible damage to the amplifiers.

Charge Pump

The MAX97000's dual-mode charge pump generates both the positive and negative power supply for the headphone amplifier. To maximize efficiency, both the charge pump's switching frequency and output voltage change based on signal level.

When the input signal level is less than 10% of VDD, the switching frequency is reduced to a low rate. This minimizes switching losses in the charge pump. When the input signal exceeds 10% of VDD, the switching frequency increases to support the load current.

For input signals below 25% of VDD, the charge pump generates \pm (VDD/2) to minimize the voltage drop across the amplifier's power stage and thus improve efficiency. Input signals that exceed 25% of VDD cause the charge pump to output \pm VDD. The higher output voltage allows for full output power from the headphone amplifier.

To prevent audible gliches when transitioning from the \pm (VDD/2) output mode to the \pm VDD output mode, the charge pump transitions very quickly. This quick change draws significant current from VDD for the duration of the transition. The bypass capacitor on VDD supplies the required current and prevents droop on VDD.

The charge pump's dynamic switching mode can be turned off through the I²C interface. The charge pump can then be forced to output either \pm (VDD/2) or \pm VDD regardless of input signal level.

Class H Operation

A Class H amplifier uses a Class AB output stage with power supplies that are modulated by the output signal. In the case of the MAX97000, two nominal power-supply differentials of 1.8V (+0.9V to -0.9V) and 3.6V (+1.8V to -1.8V) are available from the charge pump. Figure 7 shows the operation of the output-voltage-dependent power supply.

Low-Power Mode

To minimize power consumption when using the headphone amplifier, enable the low-power mode. In this mode, the headphone mixers and volume control are bypassed and shut down.

I²C Slave Address

The MAX97000 uses a slave address of 0x9A or 1001101RW. The address is defined as the 7 most significant bits (MSBs) followed by the read/write bit. Set the read/write bit to 1 to configure the MAX97000 to read mode. Set the read/write bit to 0 to configure the MAX97000 to write mode. The address is the first byte of information sent to the MAX97000 after the START (S) condition.

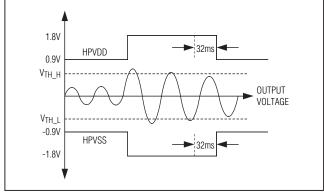


Figure 7. Class H Operation

I²C Registers

Nine internal registers program the MAX97000. Table 1 lists all the registers, their addresses, and power-on-reset states. Register 0xFF indicates the device revision.

Write zeros to all unused bits in the register table when updating the register, unless otherwise noted. Tables 2 through 7 describe each bit.

Table 1. Register Map

REGISTER	В7	В6	B5	B4	В3	B2	B1	В0	ADDRESS	DEFAULT	R/W
STATUS		,									
Input Gain	INADIFF	INBDIFF		PGAINA			PGAINB		0x00	0x00	R/W
Headphone Mixers	HPLMIX					HPRMIX			0x01	0x00	R/W
Speaker Mixer	0	0	0	0		S	PKMIX		0x02	0x00	R/W
Headphone Left	ZCD	SLEW	HPLM	HPLVOL					0x03	0x00	R/W
Headphone Right	LPGAIN	0	HPRM	RM HPRVOL					0x04	0x00	R/W
Speaker	FFM	SPKM			5	SPKVOL			0x05	0x00	R/W
Reserved	0	0	0	0	0	0	0	0	0x06	0x00	R/W
Limiter		THDC	LP		0	0	0	THDT1	0x07	0x00	R/W
Power Management	SHDN	LPMC	DE	SPKEN	KEN 0 HPLEN HPREN SWEN			0x08	0x01	R/W	
Charge Pump	0	0	0	0 0 0 CPSEL FIXED				0x09	0x00	R/W	
REVISION ID											
Rev ID				RE	V				0xFF	0x00	R

Table 2. Input Register

REGISTER	BIT	NAME	DESCRIPTION				
	7	INADIFF	Input A Differential Mode. Configures the input A channel as either a mono differential signal (INA = INA2 - INA1) or as a stereo signal (INA1 = left, INA2 = right). 0 = Stereo single-ended 1 = Differential Input B Differential Mode. Configures the input B channel as either a mono differential signal (INB = INB2 - INB1) or as a stereo signal (INB1 = left, INB2 = right). 0 = Stereo single-ended 1 = Differential				
	6	INBDIFF					
0x00	5		Input A Preamp Gain. Set the input gain to maximize output signal level for a give signal range to improve the SNR of the system. PGAINA = 111 switches to a trim feedback resistor for external gain setting.				
	4	PGAINA	VALUE LEVEL (dB) 000 -6 001 -3 010 0				
	3	011 100 101	011 3 100 6 101 9 110 18 111 External				

Table 2. Input Register (continued)

REGISTER	BIT	NAME	DESCRIPTION			
	2		signal ran	reamp Gain. Set the input gain to maximize output signal level for a given input ge to improve the SNR of the system. PGAINB = 111 switches to a trimmed $20k\Omega$ resistor for external gain setting.		
			VALUE	LEVEL (dB)		
	1	PGAINB	000	-6		
	'		001	-3		
		1 0/ 1111	010	0		
			011	3		
			100	6		
	0		101	9		
			110	18		
			111	External		

Mixers

Table 3. Mixer Registers

REGISTER	BIT	NAME		DESCRIPTION	
	7		Left Headphone Mixer. Selects which of the four inputs is routed to the left headphone output.		
	6		VALUE	INPUT	
		HPLMIX	0000	No input	
	5	=	xxx1	INA1 (Disabled when INADIFF = 1)	
			xx1x	INA2 (Select when INADIFF = 1)	
	4		x1xx	INB1 (Disabled when INBDIFF = 1)	
0x01	4		1xxx	INB2 (Select when INBDIFF = 1)	
0.001	3		Right Head	Iphone Mixer. Selects which of the four inputs is routed to the right headphone output.	
	2		VALUE	INPUT	
	~	HPRMIX	0000	No input	
	4	LIFUIVIIA	xxx1	INA1 (Disabled when INADIFF = 1)	
	'		xx1x	INA2 (Select when INADIFF = 1)	
	_		x1xx	INB1 (Disabled when INBDIFF = 1)	
	0		1xxx	INB2 (Select when INBDIFF = 1)	
	3		Speaker M	lixer. Selects which of the four inputs is routed to the speaker output.	
	2		VALUE	INPUT	
0x02		SPKMIX	0000	No input	
0.02	1	OI ICIVIIX	xxx1	INA1 (Disabled when INADIFF = 1)	
	'		xx1x	INA2 (Select when INADIFF = 1)	
	0		x1xx	INB1 (Disabled when INBDIFF = 1)	
	0		1xxx	INB2 (Select when INBDIFF = 1)	

Volume Control

Table 4. Volume Control Registers

REGISTER	BIT	NAME			DE	SCRIPTION		
	7	ZCD	Zero-Crossing Detection. Determines whether zero-crossing detection is used on all volume control changes to reduce clicks and pops. Disabling zero-crossing detection allows volume changes to occur immediately. 0 = Enabled 1 = Disabled					
	6	SLEW	changes to MAX97000 volume is m time dependent volume chat and power-0 = Enabled	Volume Slewing. Determines whether volume slewing is used on all volume control changes to reduce clicks and pops. When enabled, volume changes cause the MAX97000 to ramp through intermediate volume settings whenever a change to the volume is made. If $\overline{ZCD} = 1$, slewing occurs at a rate of 0.2ms per step. If $\overline{ZCD} = 0$, slettime depends on the input signal. Write a 1 to this bit to disable slewing and implement volume changes immediately. This bit also activates soft-start at power-on and soft-stot and power-off. $0 = \text{Enabled}$ $1 = \text{Disabled}$				
	5	HPLM	Left Headphone Mute 0 = Unmuted 1 = Muted					
0x03	4		Left Headp	hone Volume				
	3	HPLVOL	0x00 0x01 0x02	-64 -60 -56	0x10 0x11 0x12	-12 -10 -8		
	2		0x03 0x04 0x05 0x06 0x07	-52 -48 -44 -40 -37	0x13 0x14 0x15 0x16 0x17	-6 -4 -2 -1 0		
	1		0x07 0x08 0x09 0x0A 0x0B	-37 -34 -31 -28 -25	0x17 0x18 0x19 0x1A 0x1B	1 2 3 4		
	0		0x0C 0x0D 0x0D 0x0E 0x0F	-23 -22 -19 -16 -14	0x1C 0x1D 0x1E 0x1E	4.5 5 5.5 6		

Table 4. Volume Control Registers (continued)

REGISTER	BIT	NAME	DESCRIPTION							
	7	LPGAIN	Low-Power 0 = 0dB 1 = 3dB							
	5	HPRM	Right Headphone Mute 0 = Unmuted 1 = Muted							
	4		Right Headp	hone Volume						
	3		0x00 0x01	-64 -60 -56	0x10 0x11 0x12	-12 -10 -8				
0x04	2	HPRVOL	0x03 0x04 0x05 0x06	-52 -48 -44 -40	0x12 0x13 0x14 0x15 0x16	-6 -6 -4 -2 -1				
	1		0x08 0x09 0x0A	-37 -34 -31 -28 -25	0x17 0x18 0x19 0x1A 0x1B	0 1 2 3 4				
	0		0x0C 0x0D 0x0E	-22 -19 -16 -14	0x1C 0x1D 0x1E 0x1F	4.5 5 5.5 6				
	7	FFM	Fixed-Frequ 0 = Spread-s	ency Oscillatio spectrum mode quency mode		s spre	ead spectrum f	rom the class D	oscillator.	
	6	SPKM	Speaker Mu 0 = Unmuted 1 = Mute							
	5		Speaker Vol			1				
0x05	4		0x00-0x18 0x19 0x1A	-30 -26	0x	(26 (27 (28	3 4 5	0x34 0x35 0x36	LEVEL (dB) 14.5 15 15.5	
0x03	3		0x1A 0x1B 0x1C 0x1D		0x 0x	(29 (2A (2B	6 7 8	0x37 0x38 0x39	16.5 16.5 17	
	2	SPKVOL	0x1E 0x1E 0x1F 0x20	-12 -10 -8 -6	0x 0x	2C 2D 2E	9 10 11	0x3A 0x3B 0x3C	17.5 18 18.5	
	1		0x20 0x21 0x22 0x23	-0 -4 -2 0	0x 0x	<2F <30 <31	12 12.5 13	0x3D 0x3E 0x3F	19 19.5 20	
	0		0x24 0x25	1	0×	<32 <33	13.5 14	UNO!		

Distortion Limiter

Table 5. Distortion Limiter Register

REGISTER	BIT	NAME		DESCRIPTION
	7		Distortion Li	mit
	6	THDCLP	VALUE 0000 0001–1001	THD LIMIT (%) Disabled ≤ 4
0x07	5		1010 1011 1100	≤ 5 ≤ 6 ≤ 8
	4		1101 1110 1111	≤ 11 ≤ 12 ≤ 15
	0	THDT1	Distortion Re 0 = 1.4s 1 = 2.8s	elease Time Constant

Power Management

Table 6. Power Management Register

REGISTER	BIT	NAME	DESCRIPTION				
	7 SHDN		Software Shutdown 0 = Device disabled 1 = Device enabled				
	6		Low-Power Headphone Mode. Enables low-power headphone mode. When activated this mode directly connects the selected channel to the headphone amplifiers, bypassing the mixers and the volume control. Additionally, low-power mode disables the speaker path.				
	5	LPMODE	VALUE INPUT 00 Disabled 01 INA (SE) Connected to the headphone output 10 INB (SE) Connected to the headphone output 11 INA (Diff) to HPL and INB (Diff) to HPR				
0x08	4	SPKEN	Speaker Amplifier Enable 0 = Disabled 1 = Enabled				
	2	HPLEN	Left Headphone Amplifier Enable 0 = Disabled 1 = Enabled				
	1	HPREN	Right Headphone Amplifier Enable 0 = Disabled 1 = Enabled				
	0	SWEN	Analog Switch 0 = Open 1 = Closed				

Charge-Pump Control

Table 7. Charge-Pump Control Register

REGISTER	BIT	NAME	DESCRIPTION
	1	CPSEL	Charge-Pump Output Select. Works with the FIXED to set ± 1.8 V or ± 0.9 V outputs on HPVDD and HPVSS. Ignored when FIXED = 0. $0 = \pm 1.8$ V on HPVDD/HPVSS $1 = \pm 0.9$ V on HPVDD/HPVSS
0x09	0	FIXED	Class H Mode. When enabled, this bit forces the charge pump to generate static power rails for HPVDD and HPVSS, instead of dynamically adjusting them based on output signal level. 0 = Class H mode 1 = Fixed-supply mode

I²C Serial Interface

The MAX97000 features an I²C/SMBus[™]-compatible. 2-wire serial interface consisting of a serial-data line (SDA) and a serial-clock line (SCL). SDA and SCL facilitate communication between the MAX97000 and the master at clock rates up to 400kHz. Figure 1 shows the 2-wire interface timing diagram. The master generates SCL and initiates data transfer on the bus. The master device writes data to the MAX97000 by transmitting the proper slave address followed by the register address and then the data word. Each transmit sequence is framed by a START (S) or REPEATED START (Sr) condition and a STOP (P) condition. Each word transmitted to the MAX97000 is 8 bits long and is followed by an acknowledge clock pulse. A master reading data from the MAX97000 transmits the proper slave address followed by a series of nine SCL pulses. The MAX97000 transmits data on SDA in sync with the master-generated SCL pulses. The master acknowledges receipt of each byte of data. Each read sequence is framed by a START or REPEATED START condition, a not acknowledge, and a STOP condition. SDA operates as both an input and an open-drain output. A pullup resistor, typically greater than 500Ω , is required on SDA. SCL operates only as an input. A pullup resistor, typically greater than 500Ω , is required on SCL if there are multiple masters on the bus, or if the single master has an open-drain SCL output. Series resistors in line with SDA and SCL are optional. Series resistors protect the digital inputs of the MAX97000 from high-voltage spikes on the bus lines, and minimize crosstalk and undershoot of the bus signals.

Bit Transfer

One data bit is transferred during each SCL cycle. The data on SDA must remain stable during the high period of the SCL pulse. Changes in SDA while SCL is high are control signals (see the *START* and *STOP* Conditions section).

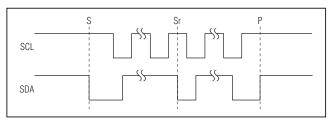


Figure 8. START, STOP, and REPEATED START Conditions

START and STOP Conditions

SDA and SCL idle high when the bus is not in use. A master initiates communication by issuing a START condition. A START condition is a high-to-low transition on SDA with SCL high. A STOP condition is a low-to-high transition on SDA while SCL is high (Figure 8). A START condition from the master signals the beginning of a transmission to the MAX97000. The master terminates transmission and frees the bus by issuing a STOP condition. The bus remains active if a REPEATED START condition is generated instead of a STOP condition.

Early STOP Conditions

The MAX97000 recognizes a STOP condition at any point during data transmission except if the STOP condition occurs in the same high pulse as a START condition. For proper operation, do not send a STOP condition during the same SCL high pulse as the START condition.

Slave Address

The slave address is defined as the seven most significant bits (MSBs) followed by the read/write bit. For the MAX97000 the seven most significant bits are 1001101. Setting the read/write bit to 1 (slave address = 0x9B) configures the MAX97000 for read mode. Setting the read/write bit to 0 (slave address = 0x9A) configures the MAX97000 for write mode. The address is the first byte of information sent to the MAX97000 after the START condition.

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Acknowledge

The acknowledge bit (ACK) is a clocked 9th bit that the MAX97000 uses to handshake receipt each byte of data when in write mode (Figure 9). The MAX97000 pulls down SDA during the entire master-generated 9th clock pulse if the previous byte is successfully received. Monitoring ACK allows for detection of unsuccessful data transfers. An unsuccessful data transfer occurs if a receiving device is busy or if a system fault has occurred. In the event of an unsuccessful data transfer, the bus master will retry communication. The master pulls down SDA during the 9th clock cycle to acknowledge receipt of data when the MAX97000 is in read mode. An

acknowledge is sent by the master after each read byte to allow data transfer to continue. A not-acknowledge is sent when the master reads the final byte of data from the MAX97000, followed by a STOP condition.

Write Data Format

A write to the MAX97000 includes transmission of a START condition, the slave address with the R//W bit set to 0, 1 byte of data to configure the internal register address pointer, 1 or more bytes of data, and a STOP condition. Figure 10 illustrates the proper frame format for writing 1 byte of data to the MAX97000. Figure 11 illustrates the frame format for writing n-bytes of data to the MAX97000.

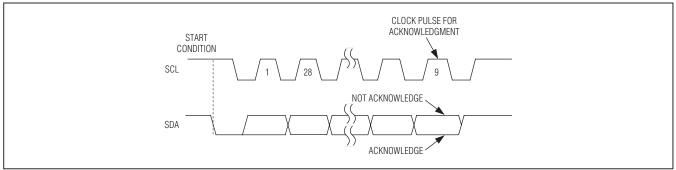


Figure 9. Acknowledge

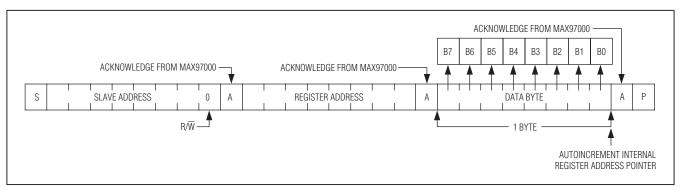


Figure 10. Writing 1 Byte of Data to the MAX97000

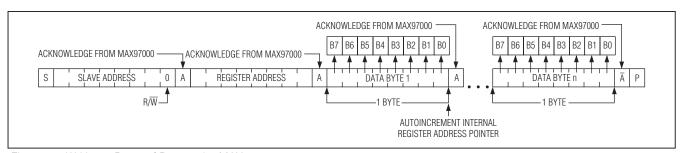


Figure 11. Writing n-Bytes of Data to the MAX97000

The slave address with the R/W bit set to 0 indicates that the master intends to write data to the MAX97000. The MAX97000 acknowledges receipt of the address byte during the master-generated 9th SCL pulse.

The second byte transmitted from the master configures the MAX97000's internal register address pointer. The pointer tells the MAX97000 where to write the next byte of data. An acknowledge pulse is sent by the MAX97000 upon receipt of the address pointer data.

The third byte sent to the MAX97000 contains the data that is written to the chosen register. An acknowledge pulse from the MAX97000 signals receipt of the data byte. The address pointer autoincrements to the next register address after each received data byte. This autoincrement feature allows a master to write to sequential registers within one continuous frame. The master signals the end of transmission by issuing a STOP condition. Register addresses greater than 0x09 are reserved. Do not write to these addresses.

Read Data Format

Send the slave address with the R/\overline{W} bit set to 1 to initiate a read operation. The MAX97000 acknowledges receipt of its slave address by pulling SDA low during the 9th SCL clock pulse. A START command followed by a read command resets the address pointer to register 0x00.

The first byte transmitted from the MAX97000 are the contents of register 0x00. Transmitted data is valid on the rising edge of SCL. The address pointer autoincrements after each read data byte. This autoincrement feature allows all registers to be read sequentially within one continuous frame. A STOP condition can be issued after any number of read data bytes. If a STOP condition is issued followed by another read operation, the first data byte to be read is from register 0x00.

The address pointer can be preset to a specific register before a read command is issued. The master presets the address pointer by first sending the MAX97000's slave address with the R/\overline{W} bit set to 0 followed by the register address. A REPEATED START condition is then sent followed by the slave address with the R/\overline{W} bit set to 1. The MAX97000 then transmits the contents of the specified register. The address pointer autoincrements after transmitting the first byte.

The master acknowledges receipt of each read byte during the acknowledge clock pulse. The master must acknowledge all correctly received bytes except the last byte. The final byte must be followed by a not acknowledge from the master and then a STOP condition. Figure 12 illustrates the frame format for reading 1 byte from the MAX97000. Figure 13 illustrates the frame format for reading multiple bytes from the MAX97000.

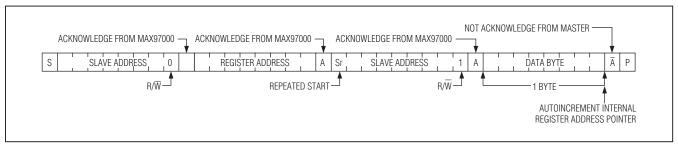


Figure 12. Reading 1 Byte of Data from the MAX97000

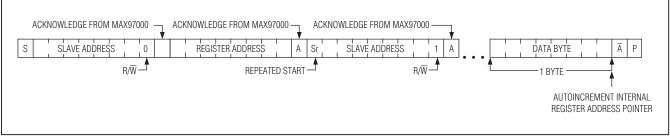


Figure 13. Reading n-Bytes of Data from the MAX97000

_Applications Information

Filterless Class D Operation

Traditional Class D amplifiers require an output filter to recover the audio signal from the amplifier's output. The filters add cost, increase the solution size of the amplifier, and can decrease efficiency and THD+N performance. The traditional PWM scheme uses large differential output swings (2 x V_{DD} peak-to-peak) and causes large ripple currents. Any parasitic resistance in the filter components results in a loss of power, lowering the efficiency.

The MAX97000 does not require an output filter. The device relies on the inherent inductance of the speaker coil and the natural filtering of both the speaker and the human ear to recover the audio component of the square-wave output. Eliminating the output filter results in a smaller, less costly, more efficient solution.

Because the frequency of the MAX97000 output is well beyond the bandwidth of most speakers, voice coil movement due to the square-wave frequency is very small. Although this movement is small, a speaker not designed to handle the additional power can be damaged. For optimum results, use a speaker with a series inductance > $10\mu H$. Typical 8Ω speakers exhibit series inductances in the $20\mu H$ to $100\mu H$ range.

RF Susceptibility

GSM radios transmit using time-division multiple access (TDMA) with 217Hz intervals. The result is an RF signal with strong amplitude modulation at 217Hz and its harmonics that is easily demodulated by audio amplifiers. The MAX97000 is designed specifically to reject RF signals; however, PCB layout has a large impact on the susceptibility of the end product.

In RF applications, improvements to both layout and component selection decrease the MAX97000's susceptibility to RF noise and prevent RF signals from being demodulated into audible noise. Trace lengths should be kept below 1/4 of the wavelength of the RF frequency of interest. Minimizing the trace lengths prevents them from functioning as antennas and coupling RF signals into the MAX97000. The wavelength (λ) in meters is given by: λ = c/f where c = 3 x 10⁸ m/s, and f = the RF frequency of interest.

Route audio signals on middle layers of the PCB to allow ground planes above and below shield them from RF interference. Ideally the top and bottom layers of the PCB should primarily be ground planes to create effective shielding.

Additional RF immunity can also be obtained from relying on the self-resonant frequency of capacitors as it exhibits the frequency response similar to a notch filter. Depending on the manufacturer, 10pF to 20pF capacitors typically exhibit self-resonance at RF frequencies. These capacitors when placed at the input pins can effectively shunt the RF noise at the inputs of the MAX97000. For these capacitors to be effective, they must have a low-impedance, low-inductance path to the ground plane. Do not use microvias to connect to the ground plane as these vias do not conduct well at RF frequencies.

Component SelectionOptional Ferrite Bead Filter

Additional EMI suppression can be achieved using a filter constructed from a ferrite bead and a capacitor to ground (Figure 14). Use a ferrite bead with low DC resistance, high-frequency (> 600MHz) impedance between 100Ω and 600Ω , and rated for at least 1A. The capacitor value varies based on the ferrite bead chosen and the actual speaker lead length. Select a capacitor less than 1nF based on EMI performance.

Input Capacitor

An input capacitor, C_{IN}, in conjunction with the input impedance of the MAX97000 line inputs forms a high-pass filter that removes the DC bias from an incoming analog signal. The AC-coupling capacitor allows the amplifier to automatically bias the signal to an optimum DC level. Assuming zero-source impedance, the -3dB point of the highpass filter is given by:

$$f_{-3dB} = \frac{1}{2\pi R_{IN} C_{IN}}$$

Choose C_{IN} such that f-3dB is well below the lowest frequency of interest. For best audio quality, use capacitors whose dielectrics have low-voltage coefficients, such as tantalum or aluminum electrolytic. Capacitors with high-voltage coefficients, such as ceramics, may result in increased distortion at low frequencies.

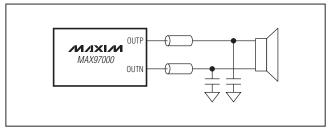


Figure 14. Optional Class D Ferrite Bead Filter

Charge-Pump Capacitor Selection

Use capacitors with an ESR less than $100m\Omega$ for optimum performance. Low-ESR ceramic capacitors minimize the output resistance of the charge pump. Most surface-mount ceramic capacitors satisfy the ESR requirement. For best performance over the extended temperature range, select capacitors with an X7R dielectric.

Charge-Pump Flying Capacitor

The value of the flying capacitor (connected between C1N and C1P) affects the output resistance of the charge pump. A value that is too small degrades the device's ability to provide sufficient current drive, which leads to a loss of output voltage. Increasing the value of the flying capacitor reduces the charge-pump output resistance to an extent. Above $1\mu F$, the on-resistance of the internal switches and the ESR of external charge-pump capacitors dominate.

Charge-Pump Holding Capacitor

The holding capacitor (bypassing HPVDD and HPVSS) value and ESR directly affect the ripple on the supply. Increasing the capacitor's value reduces output ripple. Likewise, decreasing the ESR reduces both ripple and output resistance. Lower capacitance values can be used in systems with low maximum output power levels. See the Output Power vs. Load Resistance graph in the *Typical Operating Characteristics* section for more information.

Supply Bypassing, Layout, and Grounding

Proper layout and grounding are essential for optimum performance. Use a large continuous ground plane on a dedicated layer of the PCB to minimize loop areas. Connect GND and PGND directly to the ground plane using the shortest trace length possible. Proper grounding improves audio performance, minimizes crosstalk between channels, and prevents any digital noise from coupling into the analog audio signals.

Place the capacitor between C1P and C1N as close as possible to the MAX97000 to minimize trace length from C1P to C1N. Inductance and resistance added between C1P and C1N reduce the output power of the headphone amplifier. Bypass HPVDD and HPVSS with capacitors located close to the pins with a short trace length to PGND. Close decoupling of HPVDD and HPVSS minimizes supply ripple and maximizes output power from the headphone amplifier.

Bypass PVDD to PGND with as little trace length as possible. Connect OUTP and OUTN to the speaker using the shortest and widest traces possible. Reducing trace length minimizes radiated EMI. Route OUTP/OUTN as a differential pair on the PCB to minimize the loop area and thereby the inductance of the circuit. If filter components are used on the speaker outputs, be sure to locate them as close to the MAX97000 as possible to ensure maximum effectiveness. Minimize the trace length from any ground tied passive components to PGND to further minimize radiated EMI.

An evaluation kit (EV kit) is available to provide an example layout for the MAX97000. The EV kit allows quick setup of the MAX97000 and includes easy-to-use software allowing all internal registers to be controlled.

WLP Applications Information

For the latest application details on WLP construction, dimensions, tape carrier information, PCB techniques, bump-pad layout, and recommended reflow temperature profile, as well as the latest information on reliability testing results, refer to the *Application Note: UCSP - A Wafer-Level Chip-Scale Package* on Maxim's website at www.maxim-ic.com/ucsp. See Figure 15 for the recommended PCB footprint for the MAX97000.

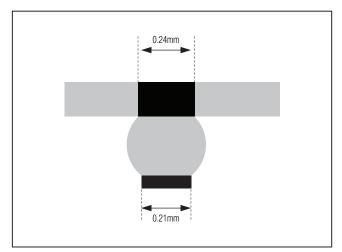
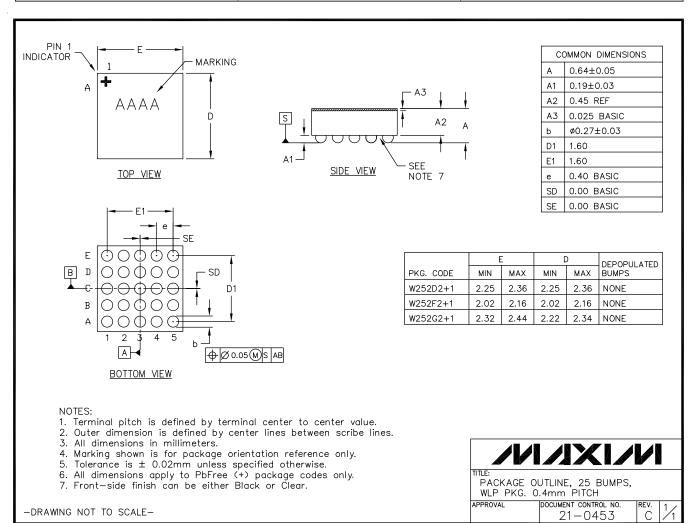


Figure 15. Recommended PCB Footprint

_Package Information

For the latest package outline information and land patterns, go to <u>www.maxim-ic.com/packages</u>. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

PACKAGE TYPE	PACKAGE CODE	DOCUMENT NO.
25 WLP	W252F2+1	21-0453



Revision History

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	11/09	Initial release	_
1	6/10	Updated to show the device allows VDD to be externally supplied	1, 4, 5, 18

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